



Xinger Balun 75Ω to 75Ω Balanced

E5300

Description

The 0922B75-37A is a low cost, low profile sub-miniature unbalanced to balanced transformer designed for differential inputs and output locations on wireless chipsets in an easy to use surface mount package covering dual polarized commercial Satellite bands 950 MHz – 2150 MHz. The 0922B75-37A is ideal for high volume manufacturing and is higher performance than traditional wire wound baluns. The 0922B75-37A has an unbalanced port impedance of 75 Ω and a 75 Ω balanced port impedance*. This transformation enables single ended signals to be applied to differential ports on modern integrated chipsets. The 0922B75-37A is available on tape and reel for pick and place high volume manufacturing.

ELECTRICAL SPECIFICATIONS**

Frequency	Unbalanced Port Impedance	Balanced Port Impedance*	Return Loss	Insertion Loss
MHz	Ohms	Ohms	dB min	dB max
950 - 2150	75	75	12	0.8***
Amplitude Balance	Phase Balance	Power Handling	ΘJC	Operating Temp.
dB	Degrees max	Watts	°C / Watt	°C
0 ± 0.7	180 ± 10	4	TBD	-55 to +85

**Specification based on performance of unit properly installed on microstrip printed circuit boards with 75 Ω + 37.5 Ω nominal impedance. Spec's subject to change without notice. * 37.5 Ω reference to ground

USA/Canada:

Toll Free:

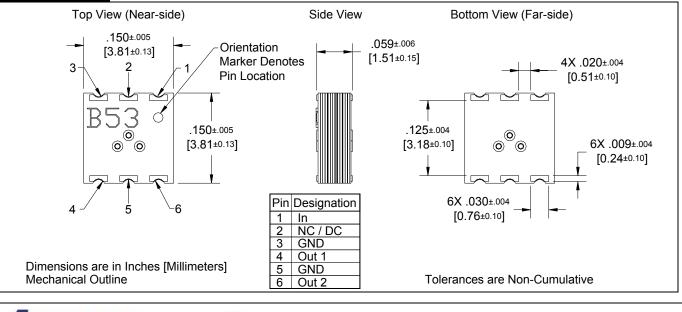
Europe:

(315) 432-8909

(800) 544-2414

+44 2392-232392

*** Insertion Loss stated at room temperature (0.9 dB Max at +85 °C)



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Available on Tape

and Reel For Pick and

Place Manufacturing.

Outline Drawing

Required

Tape & Reel

Input to Output DC Isolation

Surface Mountable

What'll we think of next

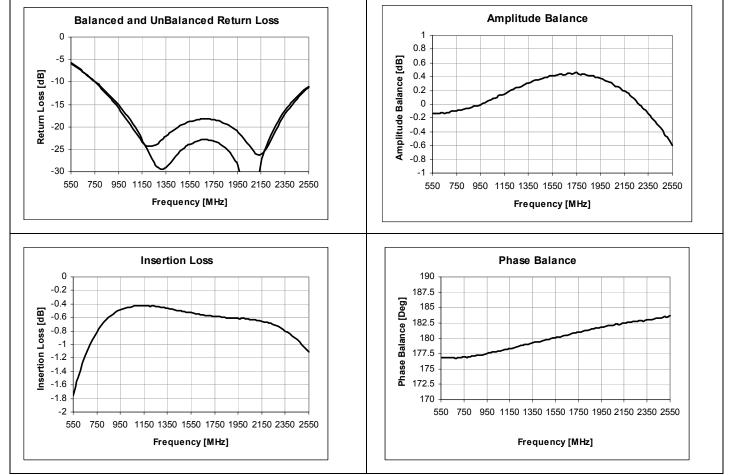
Features:

950 – 2150 MHz 180° Transformer 75 Ohm to 2 x 37.5 Ohm Low Insertion Loss Multi-band Cellular Apps Sat LNB Chipset Compliant No DC Decoupling Capacitors

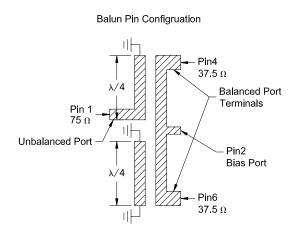


Xinger.

Typical Broadband Performance: 550 MHz. to 2550 MHz.



Pin Configuration:



The internal configuration of the Xinger® balun is diagramed to the left; the unbalanced port is DC connected to ground and the two balanced ports are DC connected and floating. For many chipset applications there is an opportunity to eliminate two decoupling capacitors and/or use a single bias point if applicable. Differential drive is popular in integrated circuit since it aids stability in the presence of bond wire and pin inductance, provides some degree of immunity to power supply and ground noise, and can provide higher output power in the case of some device limits. The construction of the Xinger® balun is bonded multi-layered stripline made of low loss dielectric material with plated through vias connecting the internal circuitry to the external printed circuit board, similar to that of the Xinger® hybrids and directional couplers.

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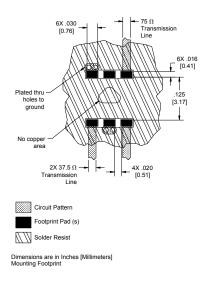




Model 0922B75-37A



Mounting Configuration:



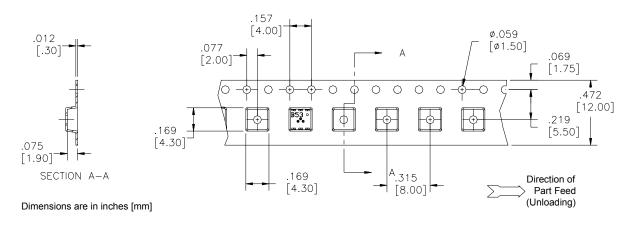
In order for Xinger surface mount components to work optimally, there must be a 75 Ω transmission line to the balanced port and 37.5 Ω transmission lines from the unbalanced ports. If this condition is not satisfied, amplitude balance, insertion loss and VSWR may not meet published specifications.

All of the Xinger components are constructed from ceramic filled PTFE composites which possess excellent electrical and mechanical stability having X and Y thermal coefficient of expansion (CTE) of 17 ppm/^oC

An example of the PCB footprint used in the testing of these parts is shown to the left. In specific designs, the transmission line widths need to be adjusted to the unique dielectric coefficients and thicknesses as well as varying pick and place equipment tolerances.

Packaging and Ordering Information

Parts are available in reel and are packaged per EIA 481-2. Parts are oriented in tape and reel as shown below. Minimum order quantities are 4000 per reel. See Model Numbers below for further ordering information.





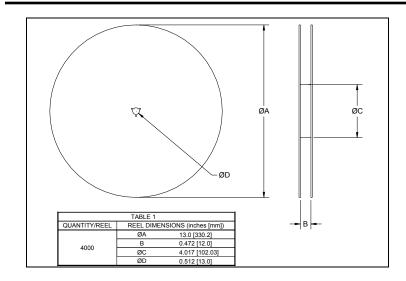


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Model 0922B75-37A





<u>4859 B 50-12 A P R</u>									
Frequency	Function	Input Impedance	Output Impedance + Coupling	Package Dimensions	Plating	Shipping Package			
$\begin{array}{rrrrrrrrrrrrrrrrrrrrrrrrrrrrrrrrrrrr$	B = Balun F = Filter FB = Filter / Balun C = 3dB Coupler DC = Directional CR = Circulator DB = Dual Balun	50 = 50 Ohm 75 = 75 Ohm	$\begin{array}{rcrcrc} 12 & = & 12.5\Omega & to Ground \\ 15 & = & 15\Omega & to Ground \\ 25 & = & 25\Omega & to Ground \\ 37 & = & 37.5\Omega & to Ground \\ 50 & = & 50\Omega & to Ground \\ 75 & = & 75\Omega & to Ground \\ 100 & = & 100\Omega & to Ground \\ 03 & = & 3dB Hybrid \\ 10 & = & 10dB Directional \\ 20 & = & 20dB Directional \\ C & = & Anti Clockwise \\ AC & = & Anti Clockwise \end{array}$	A = 150 x 150 mils (4mm x 4mm) C = 120 x 120 mils (3mm x 3mm) E = 100 x 80 mils (2.5mm x 2mm) G = 120 x 60 mils (3mm x 1.5mm) J = 80 x 50 mils (2mm x 1.25mm) L = 60 x 30 mils (1.5mm x 0.75mm) N = 140 x 80 mils (3.5mm x 2mm)	P = Lead S = Tin	R = Reel B = Bulk			

5159 = 5100 - 5900 MHz 5759 = 5700 - 5900 MHz 1414 = 14000- 14500 MHz 0819 = 800 + 1900 MHz

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